

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE (Attorney Docket No. 4492P1090US; Client No. P97-0011)

Applicant:

Ritzdorf, Thomas L.

For:

SEMICONDUCTOR PLATING SUPPORT HAVING WORKFIECE

ENGAGING ELECTRODE WITH PRE-CONDITIONED CONT

FACE

Serial No.:

08/940,686

Filed:

September 30, 1997

Examiner:

William Leader

Art Unit:

1741

RESPONSE TO OFFICE ACTION DATED OCTOBER 3, 2000

Assistant Commissioner for Patents Washington, D.C. 20231

Dear Sir:

In response to the Office Action mailed October 3, 2000, with a one-month extension, please amend the application in the following manner.

IN THE CLAIMS:

1. (Amended) [A microelectronic workpiece holder] An apparatus for use in [a microelectronic] electroplating [apparatus used to plate] a metal that is principally comprised of a metal X [or metals] onto a [microelectronic workpiece] wafer pursuant to fabricating microelectronic components on the wafer, the holder comprising:

a reactor adapted to hold an electrolyte that is used to electroplate the metal that is principally

comprised of the metal X: